

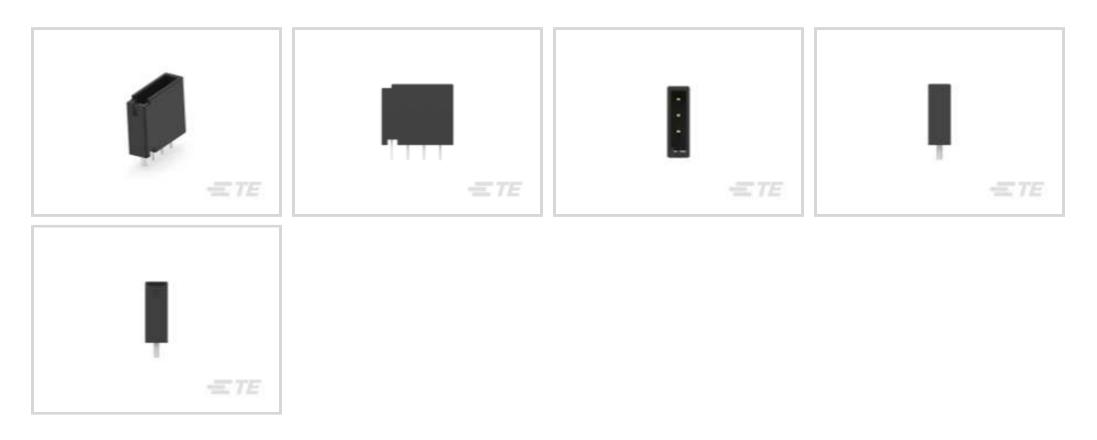
Dynamic Series | Dynamic 1000 Series

TE Internal #: 1-1827581-1 PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 3.5 mm [. 137 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 1000 Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 5A, Gold Plated



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 3

Centerline (Pitch): 3.5 mm [.137 in]

PCB Mount Orientation: Vertical

All Header Assembly: Wire-to-Board, 5A, Gold Plated (5)

Features

Product Type Features

Connector System	Wire-to-Board				
Header Type	Fully Shrouded				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
PCB Connector Assembly Type	PCB Mount Header				
Configuration Features					
Number of Positions	3				
Number of Rows	3				
PCB Mount Orientation	Vertical				
Body Features					
Primary Product Color	Black				
Contact Features					

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Contact Mating Area Plating Material Thickness	.38 μm[15 μin]				
Contact Mating Area Plating Material	Gold				
Contact Type	Pin				
Contact Current Rating (Max)	5 A				
Termination Features					
Termination Method to Printed Circuit Board	Through Hole - Solder				
Mechanical Attachment					
Mating Alignment Type	Keyed				
Mating Retention	With				
PCB Mount Retention Type	Retention Leg				
Connector Mounting Type	Board Mount				
Mating Alignment	With				
PCB Mount Alignment	Without				
PCB Mount Retention	With				
Housing Features					
Housing Material	Polyester GF				
Centerline (Pitch)	3.5 mm[.137 in]				

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]				
Operation/Application					
Circuit Application	Power & Signal				
Industry Standards					
UL Flammability Rating	UL 94V-0				
Packaging Features					
Packaging Type	Box, Tube				
Product Compliance For compliance documentation, visit the product page on TE.com>					
EU RoHS Directive 2011/65/EU	Compliant				
EU ELV Directive 2000/53/EC	Compliant				
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold				
EU REACH Regulation (EC) No. 1907/2006					

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Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

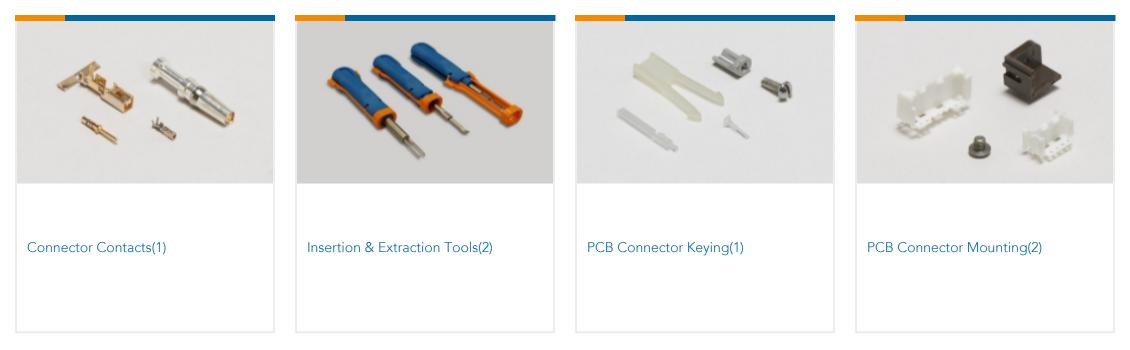
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



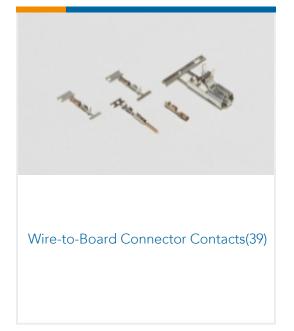
Also in the Series | Dynamic 1000 Series



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Customers Also Bought



TE Part #5747845-4	TE Part #1462039-2	TE Part #3-1461491-3	TE Part #350793-1
15 MSFL RCPT RA 318 (IN,FM,BL)	IM07CGR=IM RELAY 200mW 24V HDV	PCN-112D3MHZ,000	04P UMNL PIN HDR ASSY 94VO
age			
TE Part #350787-1	TE Part #825433-4	TE Part #147721-3	TE Part #1-1318114-3
02P UMNL PIN HDR ASSY 94VO	MOD 2 PINHDR 1X4 P.	04 MODII HORZ SR SFMNT 30AU	DYNAMIC D-2100 TAB HSG 6P P/M

Documents

Product Drawings DYNAMIC 1500T HDR ASSY V 3P X BLACK GOLD

Japanese

CAD Files

Customer View Model

ENG_CVM_CVM_1-1827581-1_C.2d_dxf.zip

English

3D PDF

C For support call+1 800 522 6752

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3D

Customer View Model ENG_CVM_CVM_1-1827581-1_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-1827581-1_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Application Specification

English

Agency Approvals TUV Certificate

English